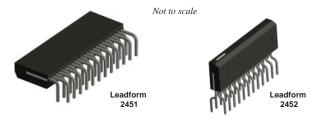




Features and Benefits

- Built-in pre-drive IC
- MOSFET power element
- Alleviate noise generation by adjusting an internal resistor
- CMOS compatible input (5 V)
- High-side gate driver using bootstrap circuit or floating power supply
- Built-in protection circuit for controlling power supply voltage drop (UVLO on VCC)
- Overcurrent protection (OCP), overcurrent limiting (OCL), and thermal shutdown (TSD)
- Output of fault signal during operation of protection circuit
- Output current 1.5, 2, or 2.5 A
- Small SIP (SMA 24-pin)

Packages: Power SIP



Description

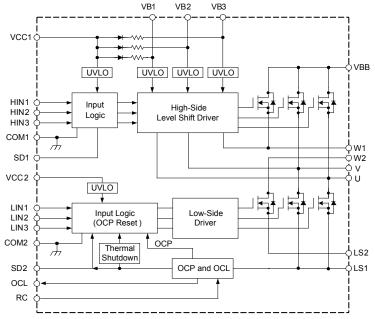
The SMA6860M inverter power module (IPM) series provides a robust, highly-integrated solution for optimally controlling 3-phase motor power inverter systems and variable speed control systems used in energy-conserving designs to drive motors of residential and commercial appliances. These ICs take 230 VAC input voltage, and up to 2.5 A (continuous) output current. They can withstand voltages of up to 500 V (MOSFET breakdown voltage).

The SMA6860M power package includes an IC with all of the necessary power elements (six MOSFETs), pre-driver ICs (two), and bootstrap diodes (three), needed to configure the main circuit of an inverter. This enables the main circuit of the inverter to be configured with fewer external components than traditional designs.

Applications include residential white goods (home applications) and commercial appliance motor control:

- · Air conditioner fan
- Small ventilation fan
- · Dishwasher pump

Functional Block Diagram



- A. SD1, SD2 terminals are used for both input and output.
- B. SD1, SD2, and OCL terminals are open-collector output. RC terminal is open-drain output.
- C. Blanking Time (t_{blank}) is used in Overcurrent Limiting (OCL) and Overcurrent Protection (OCP). If the time exceeds the limit, the signal will be output (open-collector output turns on), and protection operation will start up.

Figure 1. Driver block diagram.

High Voltage 3-Phase Motor Drivers

Selection Guide

		MOSFET Breakdown	Output	Current
Part Number	Packing	Voltage, V _{DSS} (min) (V)	Continuous, I _O (max) (A)	Pulsed, I _{OP} (max) (A)
SMA6861M	18 pieces per tube	250	2	4
SMA6862M	18 pieces per tube	500	1.5	3
SMA6863M	18 pieces per tube	500	2.5	5

Absolute Maximum Ratings, valid at T_A = 25°C

Characteristic	Symbol		Remarks	Rating	Unit
		SMA6861M		250	V
MOSFET Breakdown Voltage	V _{DSS}	SMA6862M	$V_{CC} = 15 \text{ V}, I_D = 100 \mu\text{A}, V_{IN} = 0 \text{ V}$	500	V
		SMA6863M		500	V
Logic Supply Voltage	V _{CC}	Between VCC a	and COM	20	V
Bootstrap Voltage	V _{BS}	Between VB an	d HS (U,V, and W phases)	20	V
		SMA6861M		2	Α
Output Current, Continuous	Io	SMA6862M		1.5	Α
		SMA6863M		2.5	Α
		SMA6861M		4	Α
Output Current, Pulsed	I _{OP}	SMA6862M	PW ≤ 100 µs, duty cycle = 1%	3	Α
		SMA6863M		5	Α
Input Voltage	e V _{IN} HINx and		pins	-0.5 to 7	V
Pull-up Voltage for Shutdown Pins	V _{SDX}	SDx pins		7	V
Pull-up Voltage for Overcurrent Limiting Pin	V _{OCL}			7	V
Allowable Power Dissipation	P _D	T _C = 25°C		28	W
Thermal Resistance (Junction to Case)	R _{eJC}	All elements op	erating	4.46	°C/W
Thermal Resistance (Junction to Ambient) R _{θJA}		All elements op	erating	31.25	°C/W
Case Operating Temperature	T _{COP}			-20 to 100	°C
Junction Temperature (MOSFET)	TJ			150	°C
Storage Temperature	T _{stg}			-40 to 150	°C

All performance characteristics given are typical values for circuit or system baseline design only and are at the nominal operating voltage and an ambient temperature, T_A , of 25°C, unless otherwise stated.





High Voltage 3-Phase Motor Drivers

Recommended Operating Conditions

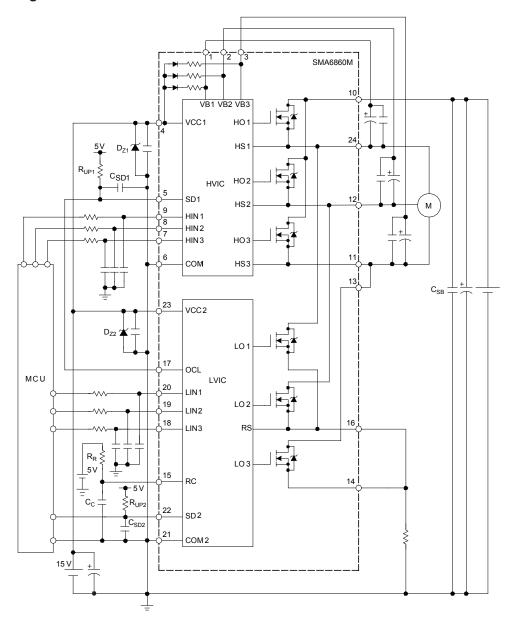
Characteristic	Symbol		Remarks	Min.	Тур.	Max.	Units
		SMA6861M		_	_	200	V
Main Supply Voltage	V _{BB}	SMA6862M	Between VBB and LS	_	-	400	V
		SMA6863M		_	_	400	V
V _{BB} Snubber Capacitor	C _{SB}			0.01	_	0.1	μF
Logic Supply Voltage	V _{CC}	Between VCC and	COM	13.5	15	16.5	V
Zener Voltage for VCCx Pins	Vz	Between VCC and	COM	18	_	20	V
Pull-up Voltage	V _{SDx} , V _{OCL}			4.5	5	5.5	V
Pull-up Resistor SD2 Pin	R _{UP2}			3.3	_	10	kΩ
Pull-up Resistor OCL Pin	R _{UP1}			1	_	10	kΩ
Pull-up Resistor RC Pin	R _R			33	_	390	kΩ
Capacitor SDx Pins	C _{SDX}			1	_	10	nF
Capacitor RC Pin	C _C			1	_	4.7	nF
Dead Time	t _{dead}	$T_J = -20^{\circ}\text{C to } 150^{\circ}$	°C	1.5	-	_	μs
Minimum Input Pulse Width	I _{INMIN(on)}	$T_J = -20^{\circ}\text{C to } 150^{\circ}$	°C	0.5	_	_	μs
willimum input ruise width	I _{INMIN(off)}	$T_J = -20^{\circ}\text{C to } 150^{\circ}$	°C	0.5	_	_	μs
Switching Frequency	f _{PWM}			_	-	20	kHz
Junction Temperature	TJ			_	-	125	°C





High Voltage 3-Phase Motor Drivers

Typical Application Diagram



NOTE:

The external electrolytic capacitors should be placed as close to the IC as possible, in order to avoid malfunctions from external noise interference. Put a ceramic capacitor in parallel with the electrolytic capacitor if further reduction of noise susceptibility is necessary.





High Voltage 3-Phase Motor Drivers

ELECTRICAL CHARACTERISTICS, valid at T_A=25°C, unless otherwise noted

Characteristics	Symbol		Conditions	Min	Тур	Max	Units
Logic Supply Current	I _{CC}	$V_{CC} = 15 \text{ V, } T_{C}$	c = -20°C to 125°C	_	4.2	7	mA
Bootstrap Supply Current	I _{BX}	V _{BX} = 15 V, V _H	$_{HIN}$ = 5 V, T_{C} = -20°C to 125°C	_	135	380	μA
Input Voltage	V _{IH}	V _{CC} = 15 V		_	2.9	3.4	V
Input Voltage	V _{IL}	V _{CC} = 15 V		1.6	2.1	_	V
Input Voltage Hysteresis	V _{Ihys}	V _{CC} = 15 V		_	0.8	_	V
Input Current	I _{IN}	V _{IN} = 5 V		_	230	500	μA
	V _{UVHL}	∐igh sids, hot	ween VBx and U, V, or W	9.0	10.0	11.0	V
	V_{UVHH}	nigh side, bet	ween vox and o, v, or vv	9.5	10.5	11.5	V
Undervoltage Lock Out	V _{UVHhys}	High side, hys	teresis	_	0.5	_	V
Ondervoltage Lock Out	V_{UVLL}	Low side betw	veen VCC2 and COM2	10.0	11.0	12.0	V
	V_{UVLH}	Low side, betv	veen vocz and cowz	10.5	11.5	12.5	V
	V _{UVLhys}	Low side, hyst	eresis	_	0.5	_	V
SDx and OCL Output Voltage	V _{SDX(on)} , V _{OCL}	V _{SDX} = V _{OCL} =	5 V, R_{UPX} = 3.3 kΩ	_	-	0.6	V
Overtemperature DetectionThreshold	T _{DH}			120	135	150	°C
Temperature (Activation and	T _{DL}	V _{CC} = 15 V, hig	V_{CC} = 15 V, high-side and low side		115	130	°C
Deactivation)	T _{Dhys}		_	20	_	°C	
Overcurrent Protection Trip Voltage	V _{TRIP}	V _{CC} = 15 V		0.9	1.0	1.1	V
Overcurrent Limit Reference Voltage	V _{LIM}	V _{CC} = 15 V		0.5035	0.53	0.5565	V
Overcurrent Protection Hold Time	t _p	V_{RC} = 5 V, R_R	= 360 kΩ, C _C = 0.0047 μF	_	2.0	_	ms
Blanking Time	t _{blank}	V _{CC} = 15 V		1.4	2.0	2.6	μs
		SMA6861M	V _R = 250 V	_	_	10	μA
Bootstrap Diode Leakage Current	I _{LBD}	SMA6862M	V _R = 500 V	_	-	10	μA
		SMA6863M	V _R = 500 V	_	-	10	μA
Bootstrap Diode Forward Voltage	V_{FBD}	I _F = 0.05 A		_	1.1	1.3	V
Bootstrap Diode Recovery Time	t _{rrb}	I _F / I _{RP} = 100 n	nA / 100 mA	_	70	_	ns
Bootstrap Diode Series Resistor	R _{BD}			168	210	252	Ω
		SMA6861M		250	ı	_	V
MOSFET Breakdown Voltage	V _{DSS}	SMA6862M	V_{CC} = 15 V, I_D = 100 μ A, V_{IN} = 0 V	500	ı	_	V
		SMA6863M		500	ı	_	V
		SMA6861M	V_{CC} = 15 V, V_{DS} = 250 V, V_{IN} = 0 V	_	-	100	μA
MOSFET Leakage Current	I _{DSS}	SMA6862M	V_{CC} = 15 V, V_{DS} = 500 V, V_{IN} = 0 V	_	-	100	μA
		SMA6863M	V_{CC} = 15 V, V_{DS} = 500 V, V_{IN} = 0 V	_	-	100	μA
MOSFET On State Resistance		SMA6861M	$V_{CC} = 15 \text{ V}, I_D = 1.0 \text{ A}, V_{IN} = 5 \text{ V}$	_	1.4	1.8	Ω
	R _{DS(on)}	SMA6862M	$V_{CC} = 15 \text{ V}, I_D = 1.0 \text{ A}, V_{IN} = 5 \text{ V}$	_	3.2	4.0	Ω
		SMA6863M	$V_{CC} = 15 \text{ V}, I_D = 1.5 \text{ A}, V_{IN} = 5 \text{ V}$	_	2.0	2.4	Ω
		SMA6861M	V _{CC} = 15 V, I _{SD} = 1.0 A, V _{IN} = 0 V	_	1.1	1.5	V
MOSFET Diode Forward Voltage	V _{SDF}	SMA6862M	$V_{CC} = 15 \text{ V}, I_{SD} = 1.0 \text{ A}, V_{IN} = 0 \text{ V}$	_	1.1	1.5	V
		SMA6863M	$V_{CC} = 15 \text{ V}, I_{SD} = 1.5 \text{ A}, V_{IN} = 0 \text{ V}$	_	1.1	1.5	V





High Voltage 3-Phase Motor Drivers

SMA6861M SWITCHING CHARACTERISTICS, valid at T_A=25°C, unless otherwise noted

Characteristics	Symbol	Conditions	Min	Тур	Max	Units
Switching Time, High Side	t _{dH(on)}	V_{BB} = 150 V, V_{CC} = 15 V, I_{D} = 2.0 A, 0 V \leq V_{IN} \leq 5 V	-	660	_	ns
	t _{rH}		_	25	_	ns
	t _{rrH}		_	690	_	ns
	t _{dH(off)}		_	630	_	ns
	t _{fH}		_	10	_	ns
	t _{dL(on)}	V_{BB} = 150 V, V_{CC} = 15 V, I_{D} = 2.0 A, 0 V ≤ V_{IN} ≤ 5 V	_	580	_	ns
	t _{rL}		_	50	_	ns
Switching Time, Low Side	t _{rrL}		_	95	_	ns
	t _{dL(off)}		_	540	_	ns
	t _{fL}		_	15	_	ns

SMA6862M SWITCHING CHARACTERISTICS, valid at T_A=25°C, unless otherwise noted

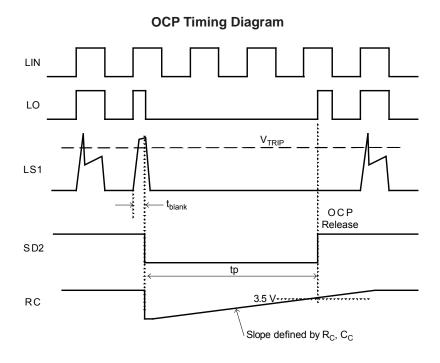
Characteristics	Symbol	Conditions	Min	Тур	Max	Units
	t _{dH(on)}		_	720	-	ns
	t _{rH}		_	40	_	ns
Switching Time, High Side	t _{rrH}	$V_{BB} = 300 \text{ V}, V_{CC} = 15 \text{ V}, I_{D} = 1.5 \text{ A}, 0 \text{ V} \le V_{IN} \le 5 \text{ V}$	_	110	-	ns
	t _{dH(off)}		_	670	-	ns
	t _{fH}		_	20	-	ns
	t _{dL(on)}	V_{BB} = 300 V, V_{CC} = 15 V, I_{D} = 1.5 A, 0 V \leq V $_{IN}$ \leq 5 V	_	600	-	ns
	t _{rL}		_	40	-	ns
Switching Time, Low Side	t _{rrL}		_	120	-	ns
	t _{dL(off)}		_	555	-	ns
	t _{fL}		_	20	_	ns

SMA6863M SWITCHING CHARACTERISTICS, valid at T_A=25°C, unless otherwise noted

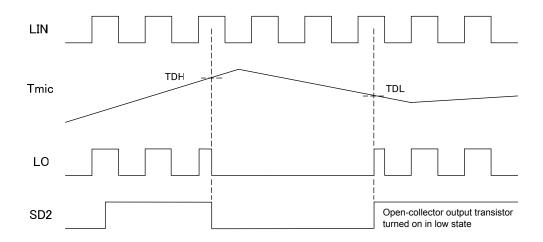
Characteristics	Symbol	Conditions	Min	Тур	Max	Units
	t _{dH(on)}		-	790	_	ns
	t _{rH}		-	60	-	ns
Switching Time, High Side	t _{rrH}	$V_{BB} = 300 \text{ V}, V_{CC} = 15 \text{ V}, I_{D} = 2.5 \text{ A}, 0 \text{ V} \le V_{IN} \le 5 \text{ V}$	-	115	-	ns
	t _{dH(off)}		-	725	_	ns
	t _{fH}		_	20	_	ns
	t _{dL(on)}	V_{BB} = 300 V, V_{CC} = 15 V, I_{D} = 2.5 A, 0 V \leq V _{IN} \leq 5 V	-	680	-	ns
	t _{rL}		_	70	_	ns
Switching Time, Low Side	t _{rrL}		_	120	_	ns
	t _{dL(off)}		_	605	-	ns
	t _{fL}		_	20	_	ns







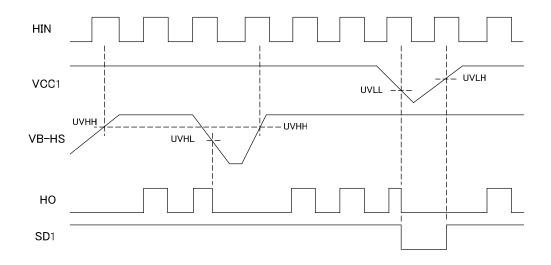
Low-Side Logic TSD Timing Diagram



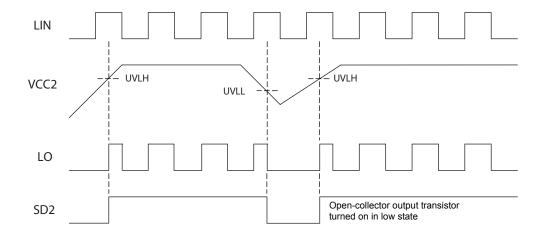




High-Side UVLO Timing Diagram



Low-Side UVLO Timing Diagram

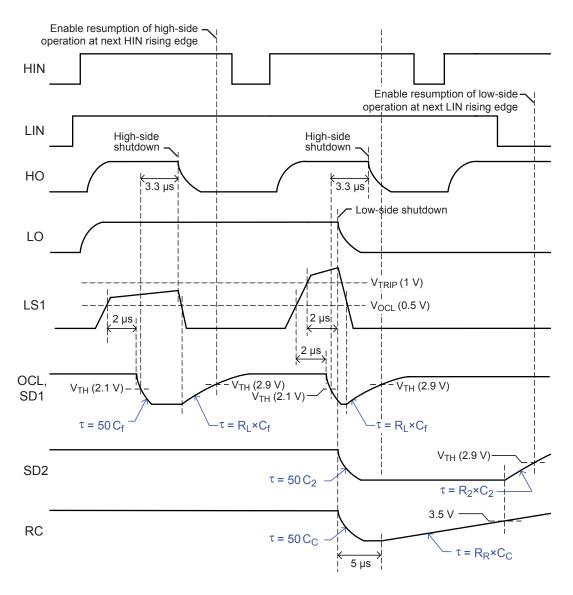






OCL Timing Diagram

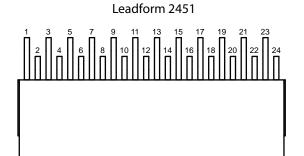
OCL and SD1 pins connected externally

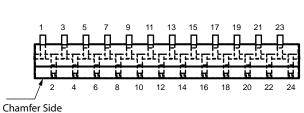






Pin-out Diagrams





Leadform 2452

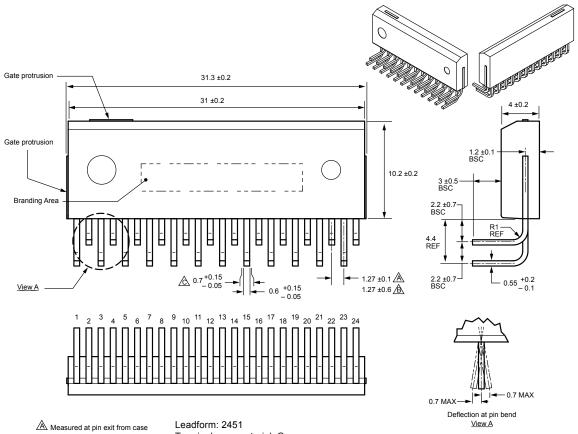
Chamfer on Opposite Side

Terminal List Table

Number	Name	Function
1	VB1	High side bootstrap terminal (U phase)
2	VB2	High side bootstrap terminal (V phase)
3	VB3	High side bootstrap terminal (W phase)
4	VCC1	High side logic supply voltage
5	SD1	High side shutdown input and UVLO fault signal output
6	COM1	High side logic GND terminal
7	HIN3	High side input terminal (W phase)
8	HIN2	High side input terminal (V phase)
9	HIN1	High side input terminal (U phase)
10	VBB	Main supply voltage
11	W1	Output of W phase (connect to W2 externally)
12	V	Output of V phase
13	W2	Output of W phase (connect to W1 externally)
14	LS2	Low side source terminal (connect to LS1 externally)
15	RC	Overcurrent protection hold time adjustment input terminal
16	LS1	Low side source terminal (connect to LS2 externally)
17	OCL	Output for overcurrent limiting
18	LIN3	Low side input terminal (W phase)
19	LIN2	Low side input terminal (V phase)
20	LIN1	Low side input terminal (U phase)
21	COM2	Low side GND terminal
22	SD2	Low side shutdown input and overtemperature, overcurrent, and UVLO fault signals output
23	VCC2	Low side logic supply voltage
24	U	Output of U phase

Package Outline Drawing Leadform 2451

Dual rows, 24 alternating pins; pins bent 90° for horizontal case mounting; pin #1 in outer row



Measured at pin tips

A Maximum dambar protrusion

Terminal core material: Cu

Terminal plating: Ni and solder (Sn 97.5%, Ag 2.5%) plating

Case material: Epoxy resin

Dimensions in millimeters

Branding codes (exact appearance at manufacturer discretion):

1st line, lot: YMDD#

Where: Y is the last digit of the year of manufacture

M is the month (1 to 9, O, N, D)

DD is the date

is the tracking letter

2nd line, type: SMA686xM



Leadframe plating Pb-free. Device composition complies with the RoHS directive.

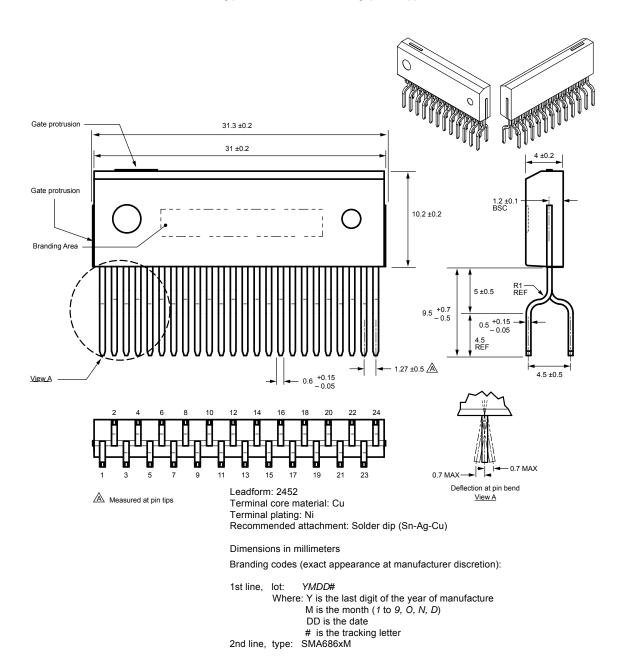




Package Outline Drawing

Leadform 2452

Dual rows, 24 alternating pins; vertical case mounting; pin #1 opposite chamfer side





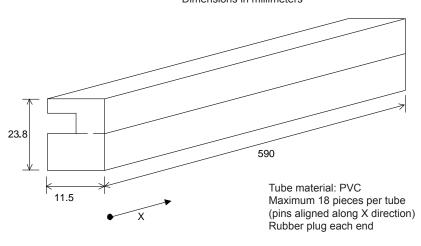
Leadframe plating Pb-free. Device composition complies with the RoHS directive.

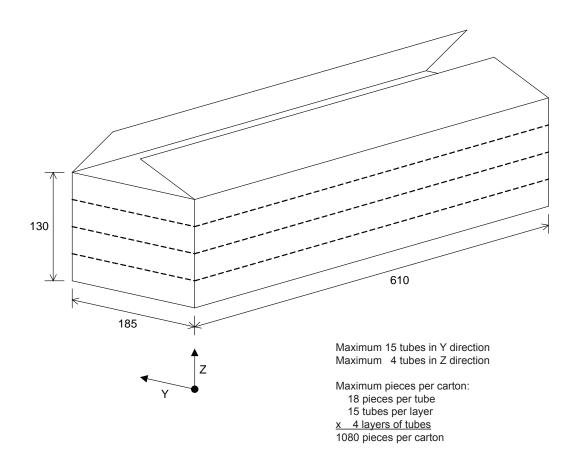




Packing Specification Leadform 2451

Dimensions in millimeters



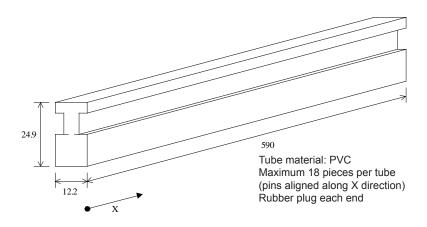


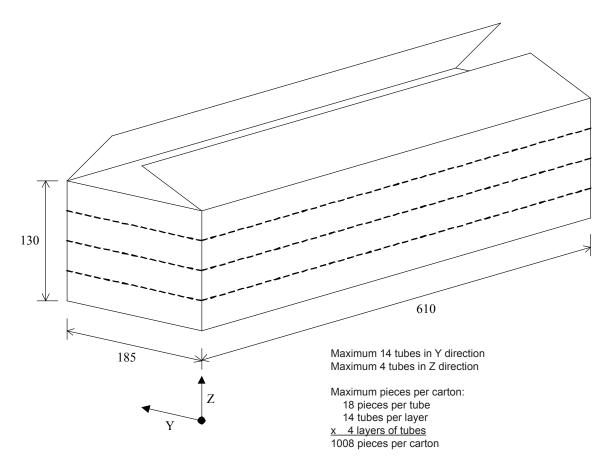




Packing Specification Leadforms 2452

Dimensions in millimeters









High Voltage 3-Phase Motor Drivers

WARNING — These devices are designed to be operated at lethal voltages and energy levels. Circuit designs that embody these components must conform with applicable safety requirements. Precautions must be taken to prevent accidental contact with power-line potentials. Do not connect grounded test equipment.

The use of an isolation transformer is recommended during circuit development and breadboarding.

Because reliability can be affected adversely by improper storage environments and handling methods, please observe the following cautions.

Cautions for Storage

- Ensure that storage conditions comply with the standard temperature (5°C to 35°C) and the standard relative humidity (around 40 to 75%); avoid storage locations that experience extreme changes in temperature or humidity.
- Avoid locations where dust or harmful gases are present and avoid direct sunlight.
- Reinspect for rust on leads and solderability of products that have been stored for a long time.

Cautions for Testing and Handling

When tests are carried out during inspection testing and other standard test periods, protect the products from power surges from the testing device, shorts between adjacent products, and shorts to the heatsink.

Remarks About Using Silicone Grease with a Heatsink

- When silicone grease is used in mounting this product on a heatsink, it shall be applied evenly and thinly. If more silicone grease than required is applied, it may produce stress.
- Volatile-type silicone greases may permeate the product and produce cracks after long periods of time, resulting in reduced heat radiation effect, and possibly shortening the lifetime of the product
- Our recommended silicone greases for heat radiation purposes, which will not cause any adverse effect on the product life, are indicated below:

Type	Suppliers
G746	Shin-Etsu Chemical Co., Ltd.
YG6260	Momentive Performance Materials, Inc.
SC102	Dow Corning Toray Silicone Co., Ltd.

Heatsink Mounting Method

Torque When Tightening Mounting Screws. The recommended tightening torque for this product package type is: 58.8 to 78.4 N•cm (6.0 to 8.0 kgf•cm).

Soldering

 When soldering the products, please be sure to minimize the working time, within the following limits:

260±5°C 10 s 380±5°C 5 s

 Soldering iron should be at a distance of at least 1.5 mm from the body of the products

Electrostatic Discharge

- When handling the products, operator must be grounded. Grounded wrist straps worn should have at least 1 MΩ of resistance to ground to prevent shock hazard.
- Workbenches where the products are handled should be grounded and be provided with conductive table and floor mats.
- When using measuring equipment such as a curve tracer, the equipment should be grounded.
- When soldering the products, the head of soldering irons or the solder bath must be grounded in other to prevent leak voltages generated by them from being applied to the products.
- The products should always be stored and transported in our shipping containers or conductive containers, or be wrapped in aluminum foil.





High Voltage 3-Phase Motor Drivers

The products described herein are manufactured in Japan by Sanken Electric Co., Ltd. for sale by Allegro MicroSystems, Inc.

Sanken and Allegro reserve the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Therefore, the user is cautioned to verify that the information in this publication is current before placing any order.

When using the products described herein, the applicability and suitability of such products for the intended purpose shall be reviewed at the users responsibility.

Although Sanken undertakes to enhance the quality and reliability of its products, the occurrence of failure and defect of semiconductor products at a certain rate is inevitable.

Users of Sanken products are requested to take, at their own risk, preventative measures including safety design of the equipment or systems against any possible injury, death, fires or damages to society due to device failure or malfunction.

Sanken products listed in this publication are designed and intended for use as components in general-purpose electronic equipment or apparatus (home appliances, office equipment, telecommunication equipment, measuring equipment, etc.). Their use in any application requiring radiation hardness assurance (e.g., aerospace equipment) is not supported.

When considering the use of Sanken products in applications where higher reliability is required (transportation equipment and its control systems or equipment, fire- or burglar-alarm systems, various safety devices, etc.), contact a company sales representative to discuss and obtain written confirmation of your specifications.

The use of Sanken products without the written consent of Sanken in applications where extremely high reliability is required (aerospace equipment, nuclear power-control stations, life-support systems, etc.) is strictly prohibited.

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